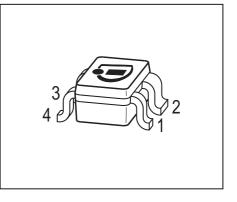


BFP182W

NPN Silicon RF Transistor*

- For low noise, high-gain broadband amplifiers at collector currents from 1 mA to 20 mA
- $f_{\rm T}$ = 8 GHz, *F* = 0.9 dB at 900 MHz
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре | Marking | Pin Configuration | | | | | Package | |
|---------|---------|-------------------|-----|-----|-------|---|---------|--------|
| BFP182W | RGs | 1=E | 2=C | 3=E | 4 = B | - | - | SOT343 |

| Maximum Ratings | | | | |
|---------------------------------------|------------------|---------|------|--|
| Parameter | Symbol | Value | Unit | |
| Collector-emitter voltage | V _{CEO} | 12 | V | |
| Collector-emitter voltage | V _{CES} | 20 | | |
| Collector-base voltage | V _{CBO} | 20 | | |
| Emitter-base voltage | V _{EBO} | 2 | | |
| Collector current | I _C | 35 | mA | |
| Base current | / _B | 4 | | |
| Total power dissipation ²⁾ | P _{tot} | 250 | mW | |
| <i>T</i> _S ≤ 91 °C | | | | |
| Junction temperature | T _i | 150 | °C | |
| Ambient temperature | T _A | -65 150 | | |
| Storage temperature | T _{stg} | -65 150 | | |
| Thermal Resistance | • - · · · | | | |

| Parameter | Symbol | Value | Unit |
|--|-------------------|-------|------|
| Junction - soldering point ³⁾ | R _{thJS} | ≤ 235 | K/W |

¹Pb-containing package may be available upon special request

 $^2 {\cal T}_S$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance



| Parameter | Symbol | Values | | | Unit |
|---|----------------------|--------|------|------|------|
| | | min. | typ. | max. |] |
| DC Characteristics | • • • | | | | , |
| Collector-emitter breakdown voltage | V _{(BR)CEO} | 12 | - | - | V |
| <i>I</i> _C = 1 mA, <i>I</i> _B = 0 | | | | | |
| Collector-emitter cutoff current | I _{CES} | - | - | 100 | μA |
| $V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0 | | | | | |
| Collector-base cutoff current | I _{CBO} | - | - | 100 | nA |
| $V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0 | | | | | |
| Emitter-base cutoff current | I _{EBO} | - | - | 1 | μA |
| $V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0 | | | | | |
| DC current gain- | h _{FE} | 70 | 100 | 140 | - |
| $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, pulse measured | | | | | |

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



| Parameter | Symbol | Values | | | Unit |
|--|---------------------------------|--------|------|------|------|
| | | min. | typ. | max. | |
| AC Characteristics (verified by random samplin | g) | T | 1 | 1 | |
| Transition frequency | f _T | 6 | 8 | - | GHz |
| <i>I</i> _C = 15 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz | | | | | |
| Collector-base capacitance | C _{cb} | - | 0.34 | 0.5 | pF |
| $V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$, | | | | | |
| emitter grounded | | | | | |
| Collector emitter capacitance | C _{ce} | - | 0.27 | - | |
| $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$, | | | | | |
| base grounded | | | | | |
| Emitter-base capacitance | C _{eb} | - | 0.8 | - | |
| $V_{\rm EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\rm CB} = 0$, | | | | | |
| collector grounded | | | | | |
| Noise figure | F | | | | dB |
| $I_{\rm C}$ = 3 mA, $V_{\rm CE}$ = 6 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, | | | | | |
| <i>f</i> = 900 MHz | | - | 0.9 | - | |
| $I_{\rm C}$ = 3 mA, $V_{\rm CE}$ = 6 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, | | | | | |
| <i>f</i> = 1.8 GHz | | - | 1.3 | - | |
| Power gain, maximum stable ¹⁾ | G _{ms} | - | 22 | - | dB |
| $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$, | | | | | |
| <i>f</i> = 900 MHz | | | | | |
| Power gain, maximum available ²⁾ | G _{ma} | - | 16.5 | - | dB |
| $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$, | | | | | |
| <i>f</i> = 1.8 GHz | | | | | |
| Transducer gain | S _{21e} ² | | | | dB |
| $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω, | | | | | |
| f = 900 MHz | | - | 18 | - | |
| $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , | | | | | |
| <i>f</i> = 1.8 GHz | | - | 12 | - | |

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$

 ${}^{2}G_{\text{ma}} = |S_{21e} / S_{12e}| (k \cdot (k^{2} \cdot 1)^{1/2})$



nH

nH

nH

nH

nΗ

nH

fF

fF

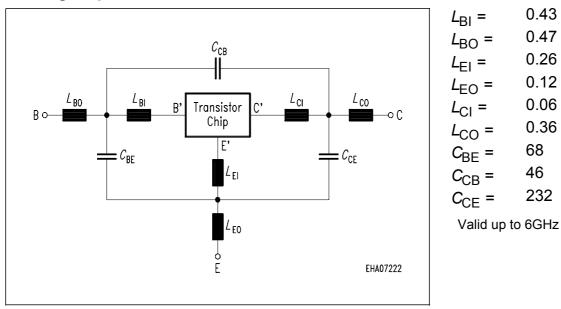
fF

SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

| Transistor Chip Data: | | | | | | | | | | |
|-----------------------|---------|----|-------|----------|-----|--------|----------|----|--|--|
| IS = | 4.8499 | fA | BF = | 84.113 | - | NF = | 0.56639 | - | | |
| VAF = | 21.742 | V | IKF = | 0.14414 | А | ISE = | 8.4254 | fA | | |
| NE = | 0.91624 | - | BR = | 10.004 | - | NR = | 0.54818 | - | | |
| VAR = | 2.2595 | V | IKR = | 0.039478 | А | ISC = | 5.9438 | fA | | |
| NC = | 0.5641 | - | RB = | 3.4217 | Ω | IRB = | 0.071955 | mΑ | | |
| RBM = | 2.8263 | Ω | RE = | 2.1858 | - | RC = | 1.8159 | Ω | | |
| CJE = | 8.8619 | fF | VJE = | 1.0378 | V | MJE = | 0.40796 | - | | |
| TF = | 22.72 | ps | XTF = | 0.43147 | - | VTF = | 0.34608 | V | | |
| ITF = | 6.5523 | mA | PTF = | 0 | deg | CJC = | 490.25 | fF | | |
| VJC = | 1.0132 | V | MJC = | 0.31068 | - | XCJC = | 0.19281 | - | | |
| TR = | 1.7541 | ns | CJS = | 0 | fF | VJS = | 0.75 | V | | |
| MJS = | 0 | - | XTB = | 0 | - | EG = | 1.11 | eV | | |
| XTI = | 3 | - | FC = | 0.64175 | | TNOM | 300 | K | | |

All parameters are ready to use, no scalling is necessary. Extracted on behalf of Infineon Technologies AG by: Institut für Mobil- und Satellitentechnik (IMST)

Package Equivalent Circuit:



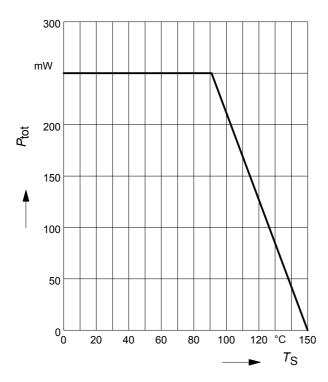
For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com



BFP182W

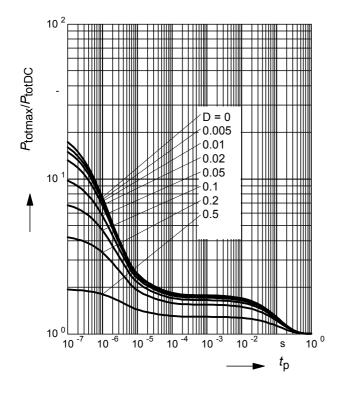
Total power dissipation $P_{tot} = f(T_S)$

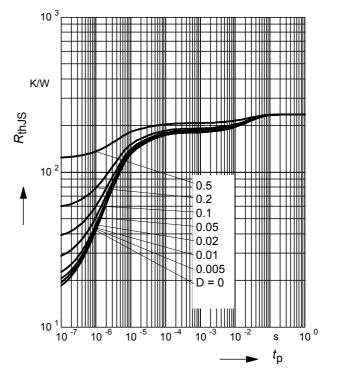
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



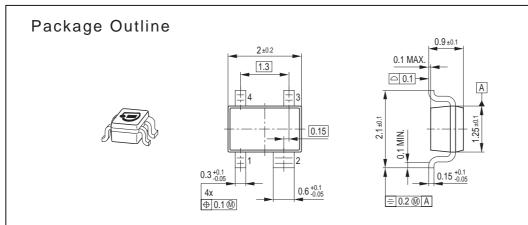
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$

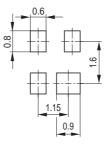




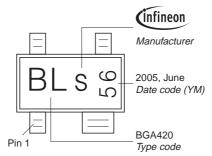




Foot Print

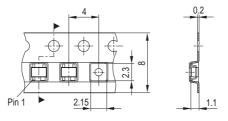


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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